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FAIRCHILD

SEMICONDUCTOR®

FAN7387V
Ballast Control IC for Compact Fluorescent Lamp

Features

- Integrated Half-Bridge MOSFET
- Internal Clock Using RCT
- Enable External Sync Function Using RCT
- Dead-Time Control by using Resistor
- Shut Down (Disable Mode)
- Internal Shunt Regulator
- UVLO Function High and Low Side

Applications

- Compact Fluorescent Lamp Ballast

Description

The FAN7387V, developed using Fairchild's unique high-voltage process and system-in-package (SiP) concept, is a ballast-control integrated circuit (IC) for a compact fluorescent lamp (CFL). The FAN7387V has a simple oscillating circuit using an external resistor and capacitor so the frequency variation is stable across the temperature range. FAN7387V has a external pin for dead time control and shutdown. By using this resistor, a designer can choose the optimum dead time to reduce the power loss on internal switching devices (MOSFETs).

8-DIP

Ordering Information

Part Number	Operating Temperature	Package	Packing Method
FAN7387VN	-40 to +125°C	8-Lead, Dual-In-line Package (DIP)	Tube

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Typical Applications Diagrams
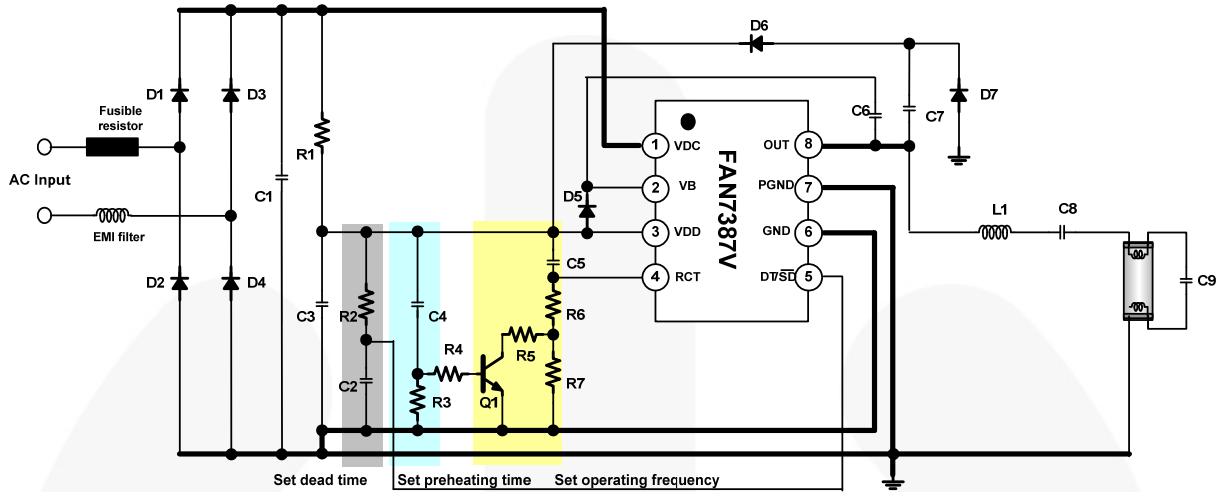
Figure 1. Typical Application Circuit for Fluorescent Lamp (Rapid Starting Method without PTC)
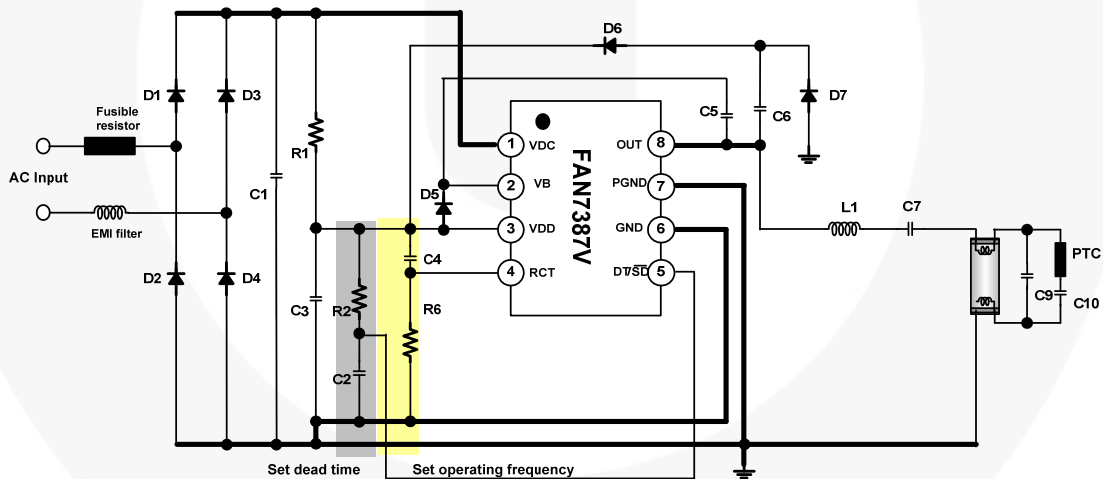
Figure 2.   Typical Application Circuit for Fluorescent Lamp (Rapid Starting Method with PTC)

Internal Block Diagram
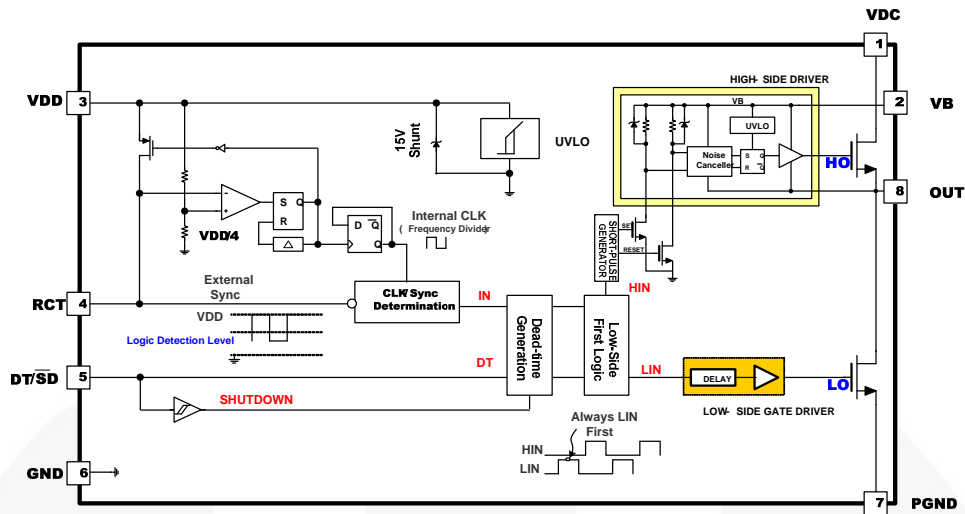
Figure 3.   Functional Block Diagram

Pin Configuration
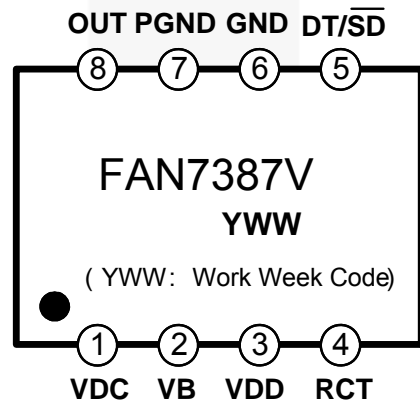
Figure 4.   Pin Configurations (Top View)

Pin Definitions

Pin #	Name	Description
1	VDC	High-voltage Supply
2	VB	High-Side Floating Supply
3	VDD	Supply Voltage
4	RCT	Oscillator Frequency Set Resistor and Capacitor
5	DT/$\overline{\text{SD}}$	Dead Time Set Resistor
6	GND	Signal Ground
7	PGND	Power Ground
8	OUT	High-Side Floating Supply Return

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. T_A=25°C unless otherwise specified.

Symbol	Parameter	Min.	Typ.	Max.	Unit
VB	High-Side Floating Supply	-0.3		465.0	V
V_{OUT}	High-Side Floating Supply Return	-0.3		440.0	V
V_{RCT}	RCT Pins Input Voltage		V_{DD}		V
I_{CL}	Clamping Current Level[1]			25	mA
dV_{OUT}/dt	Allowable Offset Voltage Slew Rate		50		V/ns
T_A	Operating Temperature Range	-40		+125	°C
T_{STG}	Storage Temperature Range	-65		+150	°C
P_D	Power Dissipation		2.1		W
Θ_{JA}	Thermal Resistance (Junction-to-Air)		70		°C/W

Note:
1. Do not supply a low-impedance voltage source to the internal clamping Zener diode between the GND and the VDD pin of this device.

Electrical Characteristics

V_{BIAS} (V_{DD}, V_B -V_{OUT})=14.0V, T_A=25°C, unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
High Voltage Supply Section						
V_{DC}	High Voltage Supply Voltage		440			V
Low-Side Supply Characteristics (V_{DD})						
VDD_{UV+}	V_{DD} UVLO Positive-Going Threshold	V_{DD} Increasing	9	11	13	V
VDD_{UV-}	V_{DD} UVLO Negative-Going Threshold	V_{DD} Decreasing	7.8	8.8	9.8	
VDD_{UHY}	V_{DD}-Side UVLO Hysteresis			2.2		
V_{CL}	Supply Camping Voltage	I_{DD}=10mA	14.4	15.4		
I_{ST}	Startup Supply Current	V_{DD}=9V		60	90	μA
I_{QDD}	Low-Side Quiescent Supply Current	R_{DT}=100kΩ		230	380	
I_{DD}	Dynamic Operating Supply Current	20kHz, C_L=1nF		0.6		mA
High-Side Supply Characteristics (VB-V_{OUT})						
V_{HSUV+}	High-Side UVLO Positive-Going Threshold	V_B-V_{OUT} Increasing	8	9	10	V
V_{HSUV-}	High-Side UVLO Negative-Going Threshold	V_B-V_{OUT} Decreasing	7.5	8.5	9.5	
V_{HSUHY}	V_{BS} Supply UVLO Hysteresis			0.5		
I_{QHS}	High-Side Quiescent Supply Current			50	90	μA
I_{PBS}	High-Side Dynamic Operating Supply Current	20kHz, C_L=1nF		130	180	
Oscillator Characteristics						
f_{osc}	Oscillation Frequency	R_T=50kΩ, C_T=330pF	18	20	22	kHz
D	Duty Cycle	Running Mode	47.5	49.0		%
V_{RCT+}	Upper Threshold Voltage of RCT	Running Mode		V_{DD}		V
V_{RCT-}	Lower Threshold Voltage of RCT	Running Mode		V_{DD}/4		
V_{IH}	Logic "1" Input Voltage of RCT	Running Mode		3/4 V_{DD}		
V_{IL}	Logic "0" Input Voltage of RCT	Running Mode			3/5 V_{DD}	
t_D	Dead Time	R_{DT}=100kΩ	440	540	640	ns
t_{DMIN}	Minimum Dead Time	$V_{DT/\overline{SD}}$=V_{DD}	280	400	520	
Protection Characteristics						
V_{SD+}	Shutdown "1" Input Voltage		2.5			V
V_{SD-}	Shutdown "0" Input Voltage	$V_{SD/\overline{DT}}$=0 After Run Mode			1	
I_{SD}	Shutdown Current				350	μA
t_{SD}	Shutdown Propagation Delay			180		Ns
Internal MOSFET Section						
I_{LKMOS}	Internal MOSFET Leakage Current	V_{DS}=400V			50	μA
R_{ON}	Static Drain-Source On-Resistance	V_{GS}=10V, I_D=190mA		4.6	6.0	Ω
I_S	Maximum Continuous Drain-Source Diode Forward Current			0.38		A
I_{SM}	Maximum Pulsed Continuous Drain-Source Diode Forward Current			3.04		A
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS}=0V, I_S=0.38A			1.2	V

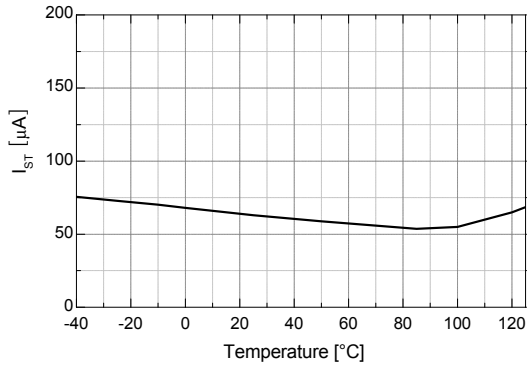## Typical Performance Characteristics

Figure 5.   Startup Current vs. Temperature
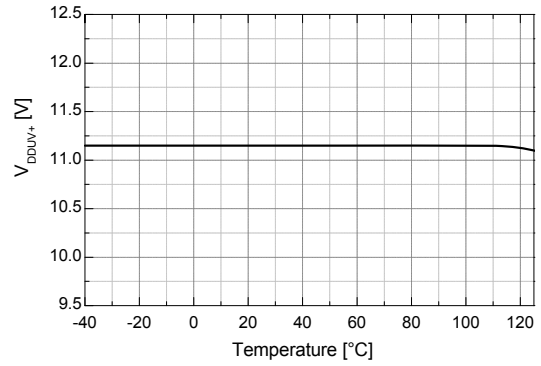

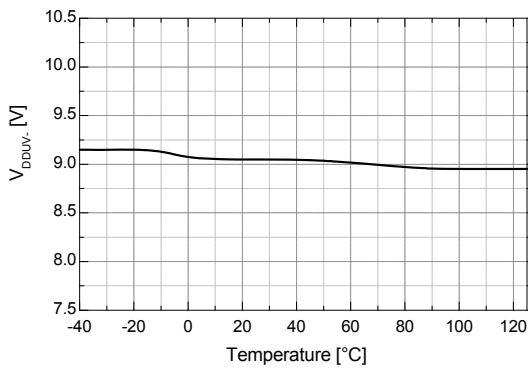**Figure 6.   V$_{DD}$ UVLO+ vs. Temperature**

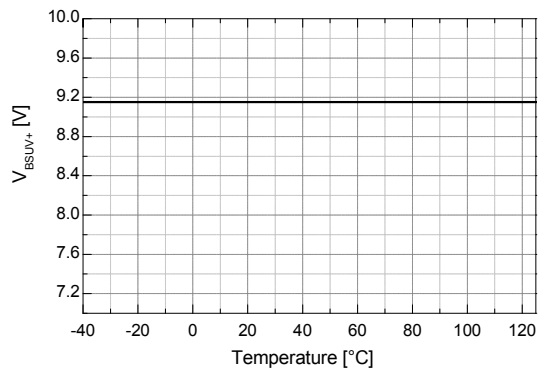**Figure 7.   V$_{DD}$ UVLO- vs. Temperature**

Figure 8.   VB-V$_{OUT}$ UVLO+ vs. Temperature
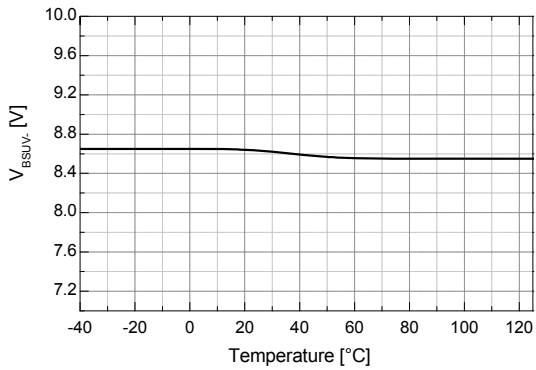

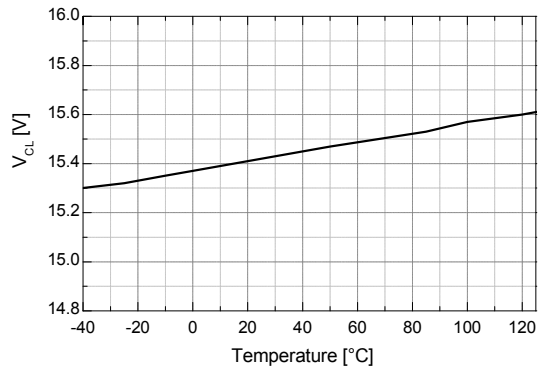**Figure 9.   VB-V$_{OUT}$ UVLO- vs. Temperature**

Figure 10. V$_{CL}$ vs. Temperature

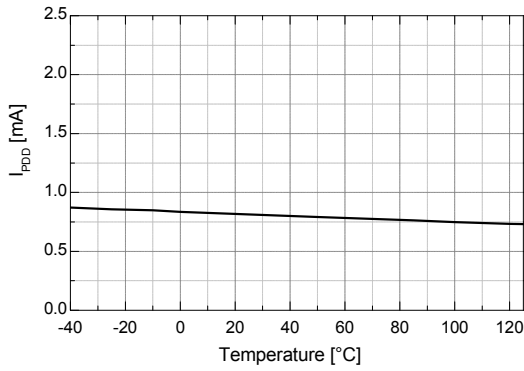## Typical Performance Characteristics (Continued)
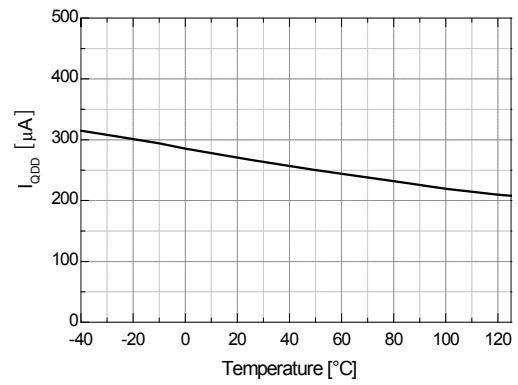

Figure 11. I_{PDD} vs. Temperature

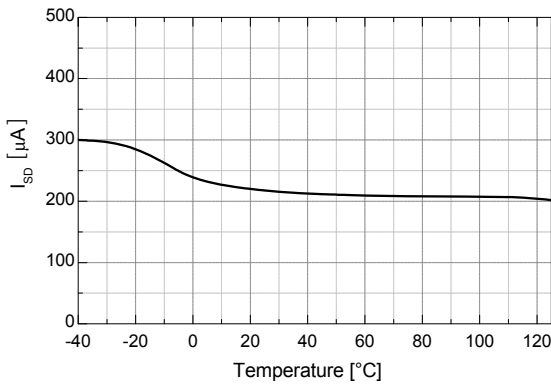
Figure 12. I_{QDD} vs. Temperature

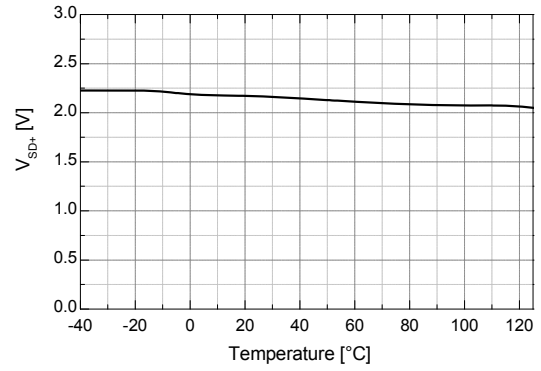Figure 13. I_{SD} vs. Temperature

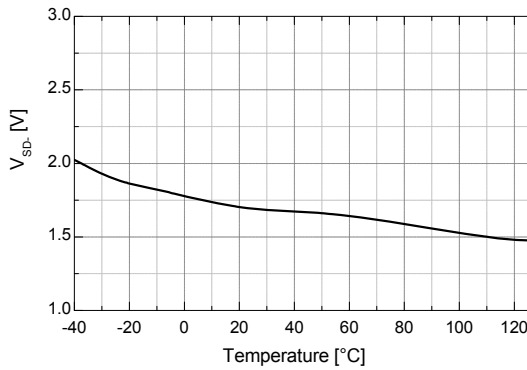Figure 14. V_{SD}+ vs. Temperature

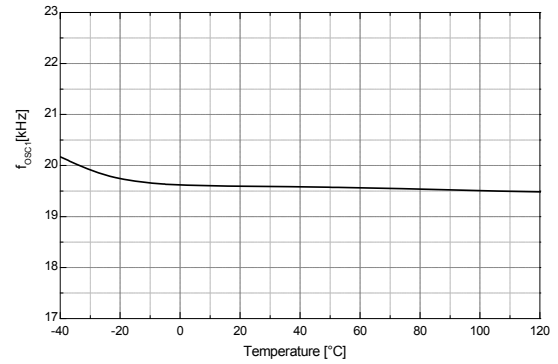Figure 15. V_{SD}- vs. Temperature

Figure 16. Operating Frequency vs. Temperature
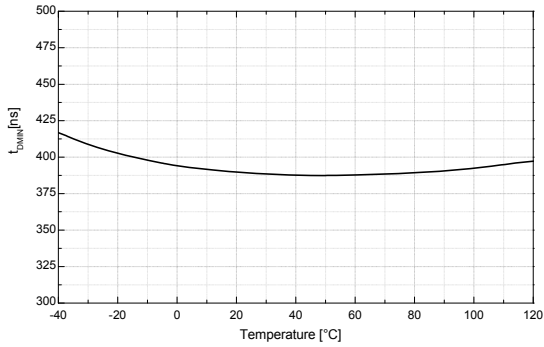
Typical Performance Characteristics (Continued)

Figure 17. t_{DMIN} vs. Temperature
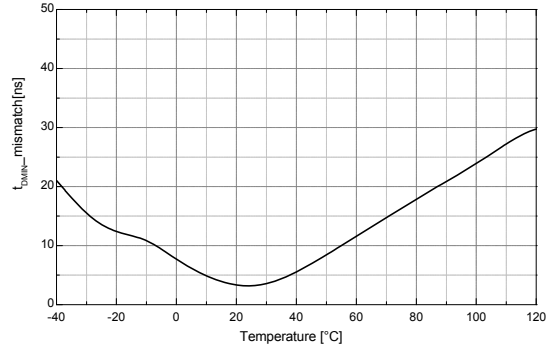

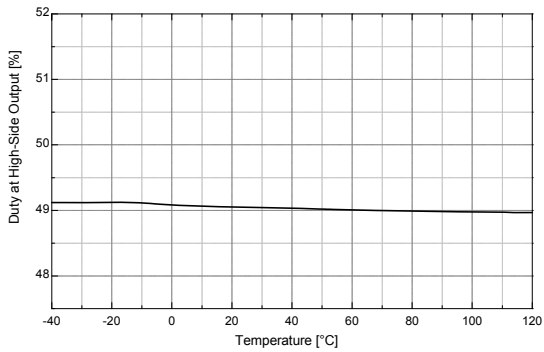**Figure 18. Dead-Time Mismatch vs. Temperature**

Figure 19. High-Side Duty Ratio vs. Temperature
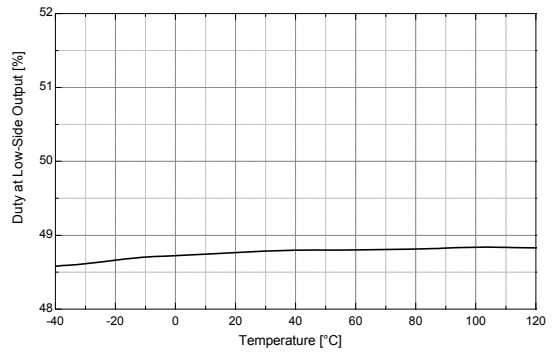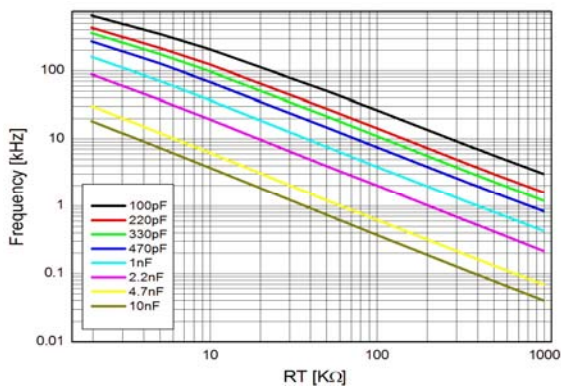

Figure 20. Low-Side Duty Ratio vs. Temperature

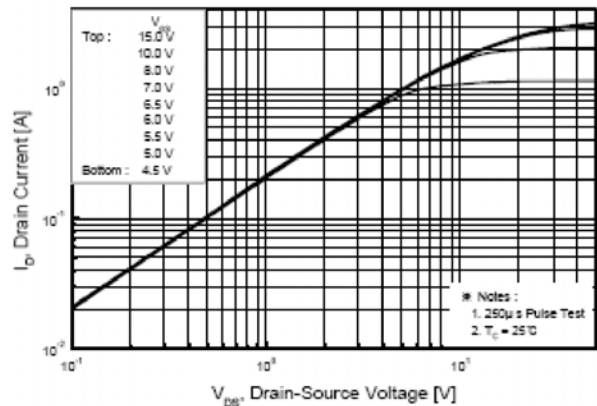**Figure 21. Frequency vs. R_T**

Figure 22. On-Region Characteristics

Typical Performance Characteristics (Continued)
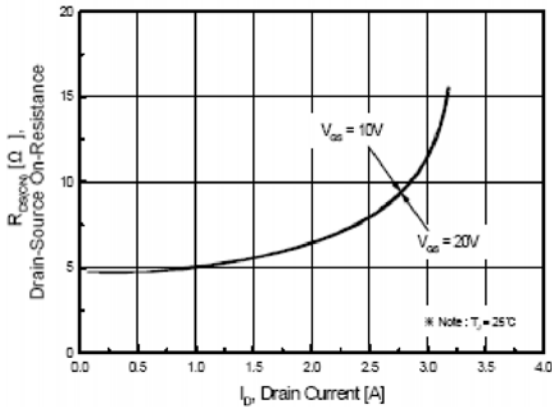
**Figure 23. On-Resistance Variation vs.
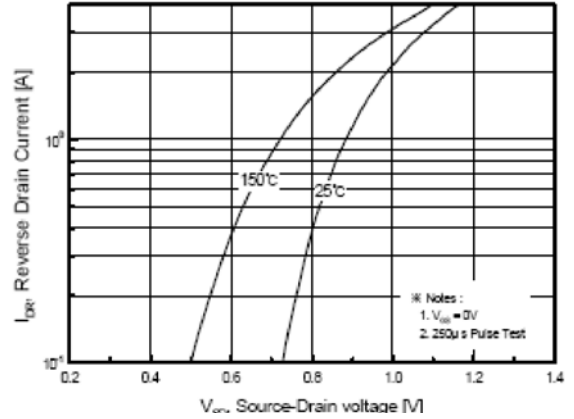Drain Current and Gate Voltage**

**Figure 24. Body Diode Forward Voltage Variation vs.
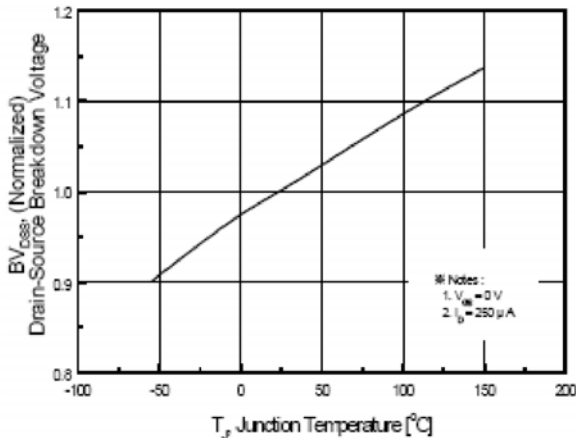Source Current and Temperature**

Figure 25. Breakdown Voltage Variation vs. Temperature
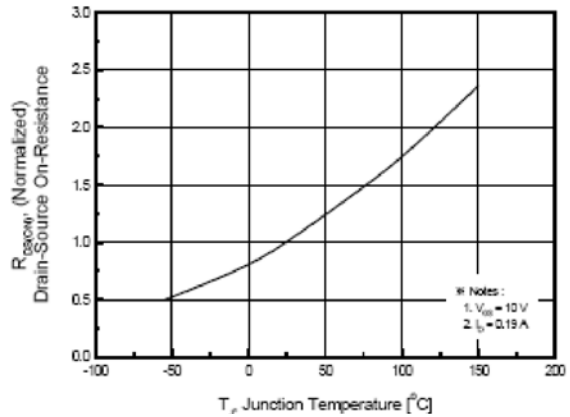
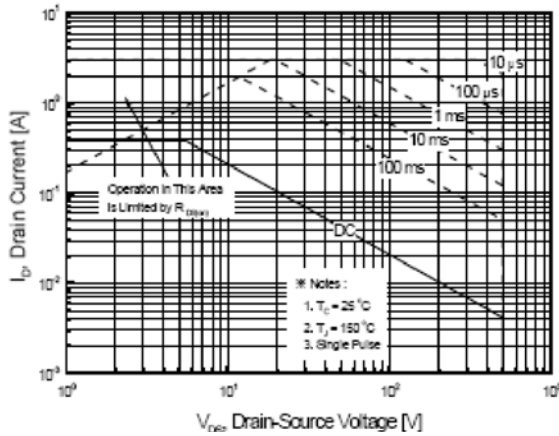**Figure 26. On-Resistance Variation vs. Temperature**

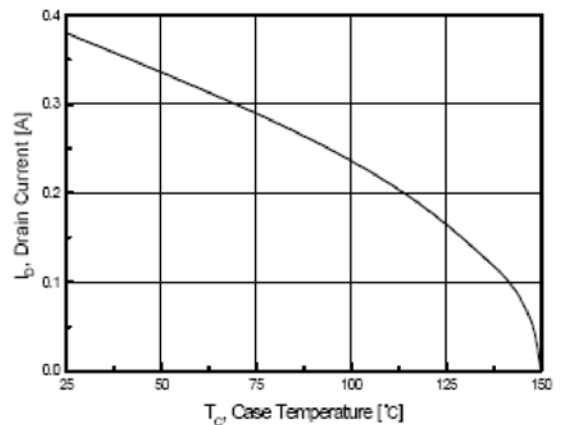**Figure 27. Maximum Safe Operating Area**

**Figure 28. Maximum Drain-Current
vs. Case Temperature**

Application Information

1. Under-Voltage Lockout (UVLO) Function

FAN7387V has a UVLO circuit for a low-side and high-side block. When V_{DD} reaches to the $VDD_{UV}+$, the UVLO circuit is released and the FAN7387V operates normally. At UVLO condition, the FAN7387V has a low supply current of less than 130µA. Once UVLO is released, FAN7387V operates normally until V_{DD} goes below $VDD_{UV}-$, the UVLO hysteresis. FAN7387V also has a high-side gate driver. The supply for the high-side driver is applied between VB and V_{OUT}. To prevent malfunction at low supply voltage between VB and V_{OUT}, FAN7387V provides an additional UVLO circuit. If VB-V_{OUT} is under $V_{HSUV}+$, the driver holds LOW state to turn off the high-side switch. Once the voltage of VB-V_{OUT} is higher than $V_{HSUV+,}$ after VB-V_{OUT} exceeds $V_{HSUV}-$, the operation of driver resumes.

2. Oscillator

The running frequency is determined by an external timing resistor (R_T) and timing capacitor (C_T). The charge time of capacitor C_T from 1/4 V_{DD} to V_{DD} determines the running frequency of gate driver output (V_{OUT}).
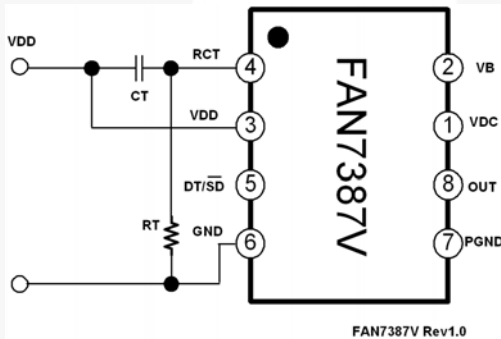

Figure 29. Typical Connection Method

Figure 30 shows the typical waveforms of RCT and internal signals (LO and HO) of IC. From the circuit analysis, the discharging time of RCT, t, is given by:

$$V_{RCT}(t) = V_{DD} \times \ln\left(\frac{-t}{R_T \bullet C_T}\right) \tag{1}$$

From Equation 1, it is possible to calculate the discharging time, t, from V_{DD} to one quarter (1/4) of V_{DD} by substituting $V_{RCT(t)}$ with 1/4 V_{DD}.
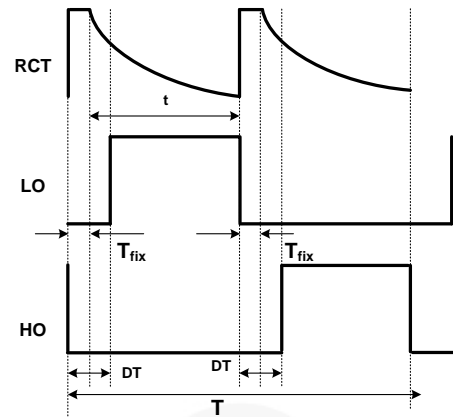

Figure 30. Typical Waveforms of RCT and Internal Signal (LO, HO) of IC

$$t = 1.38 \bullet R_T \bullet C_T \tag{2}$$

The running frequency of IC is determined by 1/t and is approximately given as:

$$f_{running} = \frac{1}{t} = \frac{1}{2(t + t_{fix})} \tag{3}$$

where t is the discharging time of the RCT voltage and t_{fix} is constant value about 450ns of IC.

3. Programming Dead Time Control / Shutdown

A multi-function pin controls dead time using an external resistor (R_{DT}) and protects abnormal condition using an external switch. This pin should be connected to an external capacitor to maintain stable operation.

If the voltage of DT/SD is decreased to under 1V by an external switch, such as the TR or MOSFET, the FAN7387V enters shutdown mode. In this mode, the FAN7387V doesn't have any output signal.
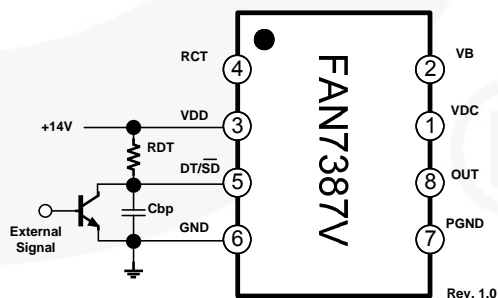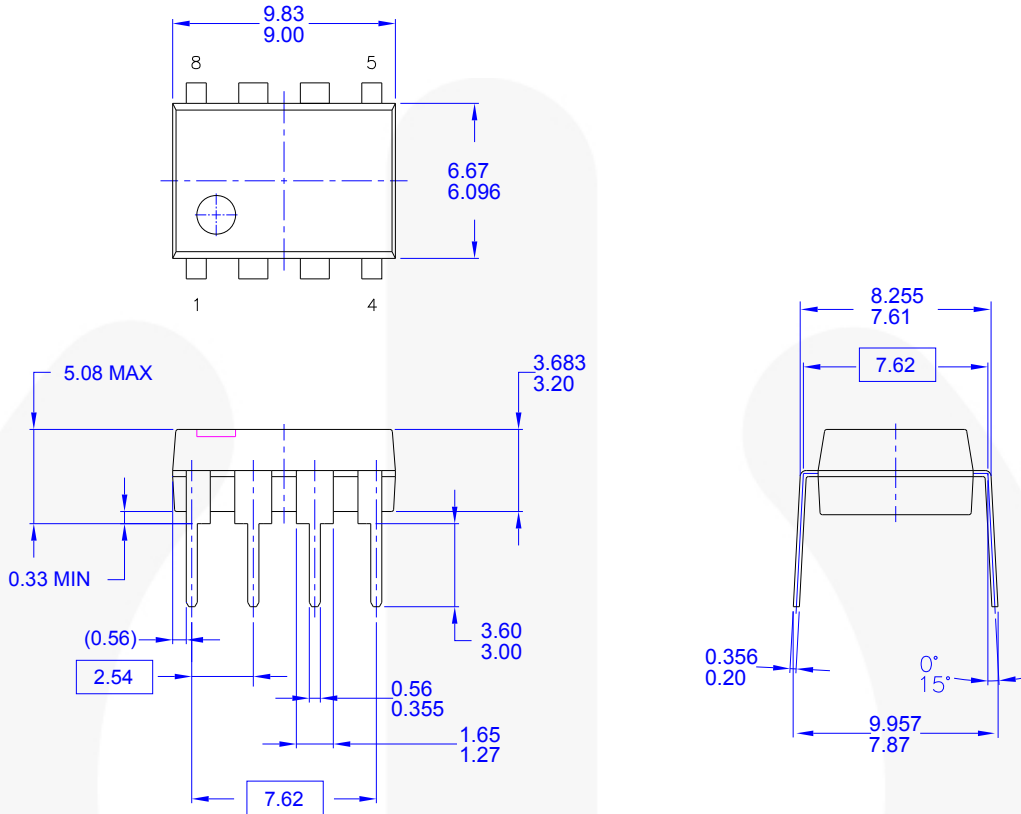

Figure 31. External Shutdown Circuit

Physical Dimensions

9.83
9.00

8   5

6.67
6.096

1   4

5.08 MAX

3.683
3.20

0.33 MIN

(0.56)

2.54

0.56
0.355

3.60
3.00

1.65
1.27

7.62

8.255
7.61

7.62

0.356
0.20

0°
15°

9.957
7.87

NOTES: UNLESS OTHERWISE SPECIFIED
  A) THIS PACKAGE CONFORMS TO
    JEDEC MS-001 VARIATION BA
  B) ALL DIMENSIONS ARE IN MILLIMETERS.
  C) DIMENSIONS ARE EXCLUSIVE OF BURRS,
    MOLD FLASH, AND TIE BAR EXTRUSIONS.
  D) DIMENSIONS AND TOLERANCES PER
    ASME Y14.5M-1994
  E) DRAWING FILENAME AND REVSION: MKT-N08FREV2.

Figure 32. 8-Lead Dual Inline Package (DIP)

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FACT®	mWSaver™	SupreMOS®	UniFET™
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FastvCore™	OPTOLOGIC®	Sync-Lock™	VisualMax™
FETBench™	OPTOPLANAR®	**SYSTEM GENERAL®***	VoltagePlus™
FlashWriter®*	®		XS™
FPS™			

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2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I61

PUBLICATION ORDERING INFORMATION